05-07-2001 101703723	RECORDATION FORM PATENTS (· ····································		
Please record the attached original doct	nts and Trademarks: uments or copy thereof.		ATTN. BOX ASSIG	INMENTS	6 LO
1. Name of conveying party(ies): Mitsuhisa OKAWA	04/25/01	2. Na	ame and address of	receiving party(ies):	841244
		Name:	YKK Corporation		996 09/
Additional name(s) of conveying party(ies) attached? □ Yes ⊠ No			Internal Address:		
3. Nature of conveyance:		Street Addr	,	Kanda Izumi-cho, a-ku, Tokyo, Japan	
		City:			
Assignment Security	Merger	State:		Zip Code:	
Agreement D	Change of Name			<u> </u>	
Other		Additional r	name(s) & Address(e	es) attached?	
Execution Date: April 12, 2001		□ Yes ⊠ No	l		
4. Application number(s) or patent number(s) application: A. Patent Application Number(s): A. Patent Application Number(s): 04/26/2001 HLE333 00000060 09841244 03 FC:581 40.00 0	<i>09 841244</i> }	B. Patent N hed? □ Yes	lumber(s): ∞ No		
5. Name and address of party to who concerning document should be r	 6. Total number of applications and registrations involved: 1 				
the French F. Chopman	7. Total fee (37 CFR 3.41): \$40 ⊠				
FINNEGAN, HENDER	Enclosed (Please charge deficiency to deposit account)				
Internal Address: <u>& DUNNER</u> , L.L.P.		Authorized to be charged to deposit account			
Street Address: 1300 Street, N.W.	8. Deposit account number: <u>06-0916</u>				
City: Washington					
State: DC Zip:	20005-3315			tached copy is a true	e copy of the
State:DCZIP.9.Statement and signature. To the best of my knowledge an original document.	d belief, the foregoing informat	ion is true and	//	pril 25, 2001	
Ernest F. Chapman	_ mitt.	ling		Date	
	Signer of pages including cover sh	eet, attachme	ents and documents	2	

PATENT REEL: 011755 FRAME: 0194

ASSIGNMENT

WHEREAS I/We, the below named inventor(s), Mitsuhisa OKAWA (hereinafter referred to as Assignors) have made an invention entitled:

SUFACE FASTENER

for which I/We executed an application for United States Letters Patent concurrently herewith or filed an application for United States Letters Patent on ______, (Serial No._____); and

WHEREAS, YKK CORPORATION, a corporation of Japan whose post address is No.1, Kanda Izumi-cho, Chiyoda-ku, Tokyo, Japan(hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention in all countries throughout the world, and in and to the application for United States Letters Patent on this invention and the Letters Patent to be issued upon this application;

NOWTHEREFORE, be it known that for and in consideration of the sum of One Dollar(\$1.00)in hand paid and other good and valuable consideration the receipt of which from assignee is hereby acknowledged, I/We, as assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the assignee, its lawful successors and assigns, my/our entire right, title, and interest in and to this invention, provisional application Serial No. _______, filed_______(if any), and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof, and all rights to claim priority on the basis of the above provisional application (if any), as well as all rights to claim priority on the basis of this applications for Letters Patent which may hereafter be filed for this invention in any foreign country and all Letters Patent which may be granted on this invention in any foreign country, and all extensions, renewals, and reissues thereof; and I/We hereby authorize and request the Commissioner of Patents and Trademarks of the United States and any official of any foreign country whose duty it is to issue patents on applications as described above, to issue all Letters Patent for this invention to assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, I/WE HEREBY covenant that I/We have the full right to convey the interest assigned by this Assignment, and I/We have not executed and will not execute any agreement in conflict with this Assignment;

AND, I/WE HEREBY further covenant and agree that I/We will, without further consideration, communicate with assignee, its successors and assigns, any facts known to me/us respecting this invention, and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver any and all papers that may be necessary or desirable to perfect the title to this invention in said assignee, its successors or assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States and any foreign country, it being understood that any expense incident to the execution of such papers shall be borne by the assignee, its successors and assigns.

IN TESTIMONY WHEREOF, I/We have hereunto set our hands.

SS.

Country of <u>Japan</u>) Pref. of <u>Toyama-ken</u>)

Name <u>Chikako HONDA</u>

Witness:

Name	Mitsuhisa OKAWA
Address	2843-6, Mikkaichi, Kurobe-shi,
	na-ken, Japan
	~

Signature Marsuhisa Chawa Date April 12

Signature <u>Likekôt konder</u> FINNEGAN, HENDERSON, FARABOW, GARRETT & DUNNER, L.L.P. • WASHINTON, D.C. **FINNEGAN, HENDERSON, FARABOW, GARRETT & DUNNER, L.L.P. • WASHINTON, D.C.**

Assignor's:

RECORDED: 04/25/2001

REEL: 011755 FRAME: 0195